

# THC63LVDF84B

24bit COLOR LVDS RECEIVER (Falling Edge Clock)

## General Description

The THC63LVDF84B receiver supports wide VCC range as 2.5 to 3.6V. At single 2.5V supply, the THC63LVDF84B reduces EMI and power consumption.

The THC63LVDF84B converts the four LVDS data streams back into 24bits of LVCMOS data with falling edge clock. At a transmit clock frequency of 85MHz, 24bits of RGB data and 4bits of timing and control data (HSYNC, VSYNC, DE, CNTL1, CNTL2) are transmitted at an effective rate of 2.38Gbps.

#### Application

- ·Medium and Small Size Panel
- Tablet PC / Notebook PC
- · Security Camera / Industrial Camera
- Multi Function Printer
- Industrial Equipment
- ·Medical Equipment Monitor

## Features

- ·1:7 LVDS to LVCMOS De-Serializer
- •Operating Temperature Range : -10 to +70°C
- •No Special Start-up Sequence Required
- Spread Spectrum Clocking Tolerant up to 100kHz Frequency Modulation and +/-2.5% Deviations.
- •Dot Clock Range: 15 to 85MHz Suited for VGA, SVGA, XGA, WXGA, 720p and 1080i.
- •56pin TSSOP Package
- •PLL requires no external components.
- ·Power Down Mode.
- Falling Edge Clock
- •EU RoHS Compliant.

## Block Diagram

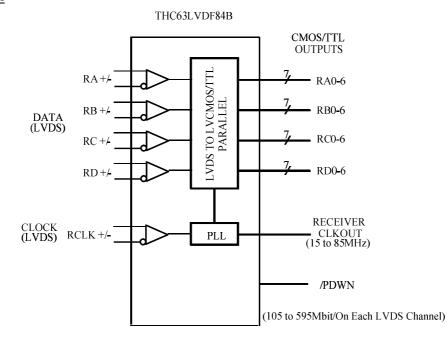


Figure 1. Block Diagram



## Pin Diagram

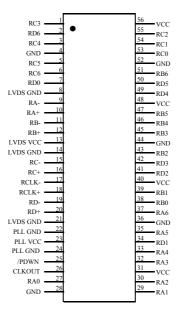


Figure 2. Pin Diagram

#### Pin Description

Din Name	Din #	Direction	Turna	Description
Pin Name	Pin #	Direction	Туре	Description
RA+, RA-	10, 9			
RB+, RB-	12, 11			LVDS Data Inputs
RC+, RC-	16, 15	Input	LVDS	
RD+, RD-	20, 19	input	LVDS	
RCLK+,	18, 17			LVDS Clock Inputs
RCLK-				
RA0 ~ RA6	27, 29, 30, 32, 33, 35, 37			
RB0 ~ RB6	38, 39, 43, 45, 46, 47, 51			Pixel Data Outputs
RC0 ~ RC6	53, 54, 55, 1, 3, 5, 6	Output		Fixel Data Outputs
RD0 ~ RD6	7, 34, 41, 42, 49, 50, 2		LVCOMS	
CLKOUT	26			Pixel Clock Output
/PDWN	25	Input		H : Normal Operation
	25	input		L : Power Down (all outputs are pulled to ground)
VCC	31, 40, 48, 56			Power Supply Pins for LVCMOS outputs and digital
				circuitry
GND	4, 28, 36, 44, 52			Ground Pins for LVCMOS outputs and digital circuitry.
LVDS VCC	13	Power	-	Power Supply Pins for LVDS inputs.
LVDS GND	8, 14, 21			Ground Pins for LVDS inputs.
PLL VCC	23			Power Supply Pins for PLL circuitry.
PLL GND	22, 24			Ground Pins for PLL circuitry.

**Table 1. Pin Description** 

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## Absolute Maximum Ratings

Parameter	Min	Max	Unit
Supply Voltage (VCC)	-0.3	+4.0	V
LVCMOS Input Voltage	-0.3	VCC + 0.3	V
LVCMOS Output Voltage	-0.3	VCC + 0.3	V
LVDS Input Pin	-0.3	VCC + 0.3	V
Junction Temperature	-	+125	О°
Storage Temperature	-55	+150	О°
Reflow Peak Temperature	-	+260	°C
Reflow Peak Temperature Time	-	10	sec
Maximum Power Dissipation @+25°C	-	1.9	W

#### **Table 2. Absolute Maximum Ratings**

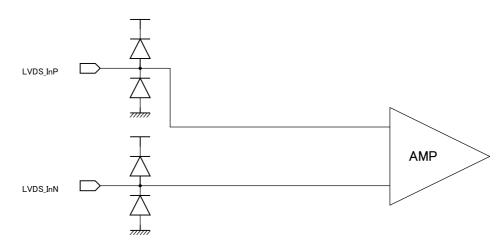
#### **Recommended Operating Conditions**

Symbol	Parameter		Min	Тур	Max	Unit
-	All Supply Voltage		2.5	-	3.6	V
Та	Operating Ambient Temperature		-10	+25	+70	°C
		VCC = 2.5V to 2.7V	20	-	70	MHz
-	Clock Frequency	VCC = 2.7V to 3.0V	15	-	70	MHz
		VCC = 3.0V to 3.6V	15	-	85	MHz

#### **Table 3. Recommended Operating Conditions**

"Absolute Maximum Ratings" are those values beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics Table4, 5, 6, 7" specify conditions for device operation. "Absolute Maximum Rating" value also includes behavior of overshooting and undershooting.

#### Equivalent LVDS Input Schematic Diagram





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## Power Consumption

Over recommended	l operating supp	oly and temperatur	e range unless	otherwise specified

Symbol	Parameter	Conditions	Тур*	Max	Unit
LVDS Receiver		RL=100Ω, CL=8pF, f=65MHz, VCC=3.3V	41	53	mA
I <sub>RCCG</sub>	Operating Current	RL=100Ω, CL=8pF, f=85MHz, VCC=3.3V	52	64	mA
		RL=100Ω, CL=8pF, f=65MHz, VCC=2.5V	30	42	mA
	LVDS Receiver	RL=100Ω, CL=8pF, f=65MHz, VCC=3.3V	72	94	mA
I <sub>RCCW</sub>	Operating Current Worst Case Pattern	RL=100Ω, CL=8pF, f=85MHz, VCC=3.3V	84	96	mA
	(Fig.5)	RL=100Ω, CL=8pF, f=65MHz, VCC=2.5V	42	64	mA
I <sub>RCCS</sub>	LVDS Receiver Power Down Current	/PDWN=L	-	10	μA

Typ values are at the conditions of  $Ta = +25^{\circ}C$ 

#### Table 4. Power Consumption

## 16 Grayscale Pattern

CLKIN		f
TA0, TB1, TC2		f/16
TA1, TB2, TC3		f/8
TA2, TB3, TC4		f/4
TA3, TB4, TC5		f/2
TA4-6, TB0,5,6 TC0,1,6, TD0-2		Steady State Low
TD3-6	Figure 4. 16 Grayscale Pattern	Steady State High
Worst Case Pat	tern	
CLKIN		Γ
Tx0-6		Γ
x=A,B,C	C,D Figure 5. Worst Case Pattern	

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## **Electrical Characteristics**

## **LVCMOS DC Specifications**

#### Over recommended operating supply and temperature range unless otherwise specified

			U		1	
Symbol	Parameter	Conditions	Min	Typ*	Max	Unit
VIH	High Level Input Voltage	-	2.0	-	VCC	V
VIL	Low Level Input Voltage	-	GND	-	0.8	V
V <sub>OH1</sub>	High Level Output Voltage	VCC = 3.0V to 3.6V I <sub>OH</sub> = -4mA	2.4	-	-	V
V <sub>OL1</sub>	Low Level Output Voltage	VCC = 3.0V to 3.6V I <sub>OL</sub> = 4mA	-	-	0.4	V
V <sub>OH2</sub>	High Level Output Voltage	VCC = 2.5V to 3.0V I <sub>OH</sub> = -2mA	2.1	-	-	V
V <sub>OL2</sub>	Low Level Output Voltage	VCC = 2.5V to 3.0V I <sub>OL</sub> = 2mA	-	-	0.4	V
l <sub>iN</sub>	Input Current	$GND \leq V_{\text{IN}} \leq VCC$	-	-	±10	μA

## **LVDS Receiver DC Specifications**

Over recommended operating supply and temperature range unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ*	Max	Unit
V <sub>TH</sub>	Differential Input High Threshold	RL=100Ω,	-	-	100	mV
V <sub>TL</sub>	Differential Input Low Threshold	VIC=+1.2V	-100	-	-	mV
I <sub>IN</sub>	Input Current	V <sub>IN</sub> = +2.4 / 0V VCC = 3.6V	-	-	±10	μA

**Table 6. LVDS Receiver DC Specifications** 

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	Over rec	ommended operating sup	oply and temper	ature range u	inless otherwise	e specified
Symbol	Parameter		Min	Тур	Max	Unit
		VCC = 2.5V to 2.7V	14.3	Т	50.0	
t <sub>RCP</sub>	CLKOUT Transition Time	VCC = 2.7V to 3.0V	14.3	Т	66.6	ns
		VCC = 3.0V to 3.6V	11.8	Т	66.6	
t <sub>RCH</sub>	CLKOUT High Time		-	4T/7	-	ns
t <sub>RCL</sub>	CLKOUT Low Time		-	3T/7	-	ns
t <sub>RCD</sub>	RCLK IN to CLKOUT +/-	Delay	-	5T/7	-	ns
t <sub>RS</sub>	LVCMOS Data Setup to	CLKOUT	0.35T - 0.3	-	-	ns
t <sub>RH</sub>	LVCMOS Data Hold from	1 CLKOUT	0.45T – 1.6	-	-	ns
t <sub>TLH</sub>	LVCMOS Low to High Tr	ansition Time	-	2.0	3.0	ns
t <sub>THL</sub>	LVCMOS High to Low Tr	ansition Time	-	1.8	3.0	ns
t <sub>RIP1</sub>	Input Data Position0 (T=	11.76ns)	-0.4	0.0	+0.4	ns
t <sub>RIP0</sub>	Input Data Position1 (T=	11.76ns)	T/7-0.4	T/7	T/7+0.4	ns
t <sub>RIP6</sub>	Input Data Position2 (T=		2T/7-0.4	2T/7	2T/7+0.4	ns
t <sub>RIP5</sub>	Input Data Position3 (T=	11.76ns)	3T/7-0.4	3T/7	3T/7+0.4	ns
t <sub>RIP4</sub>	Input Data Position4 (T=	11.76ns)	4T/7-0.4	4T/7	4T/7+0.4	ns
t <sub>RIP3</sub>	Input Data Position5 (T=	11.76ns)	5T/7-0.4	5T/7	5T/7+0.4	ns
t <sub>RIP2</sub>	Input Data Position6 (T=	11.76ns)	6T/7-0.4	6T/7	6T/7+0.4	ns
t <sub>RPLL</sub>	Phase Lock Loop Set		-	-	10.0	ms

# LVCMOS & LVDS Receiver AC Specifications

\*Typ values are at the conditions of VCC=3.3V and  $Ta = +25^{\circ}C$ 

#### Table 7. LVCMOS & LVDS Receiver AC Specifications

## LVCMOS Output

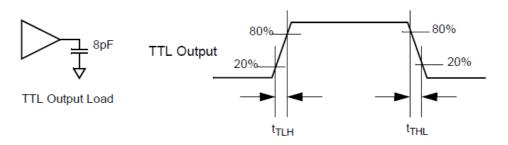


Figure 6. CLKOUT Transmission Time

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## AC Timing Diagrams

LVDS Input Data Position

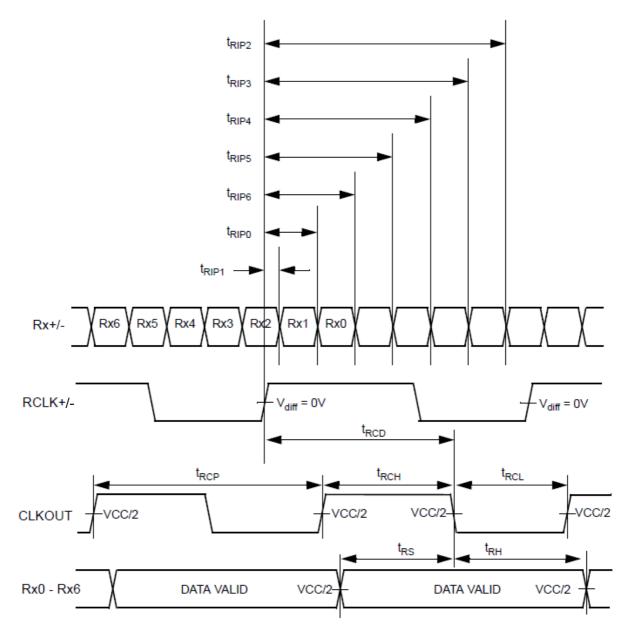


Figure 7. LVDS Input Data Position

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Phase Lock Loop Set Time

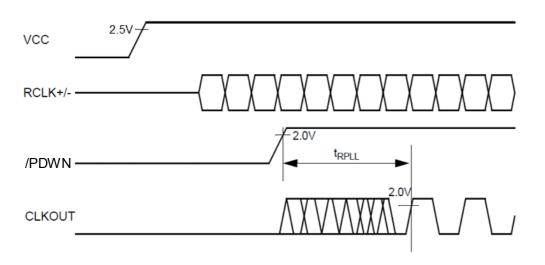
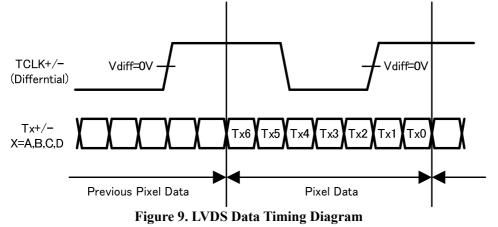


Figure 8. PLL Lock Loop Set Time

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## LVDS Data Timing Diagram



Pixel Data Mapping for JEIDA Format (6bit, 8bit Application)

TX Pin	6bit	8bit	RX Pin
TA0	R2	R2	RA0
TA1	R3	R3	RA1
TA2	R4	R4	RA2
TA3	R5	R5	RA3
TA4	R6	R6	RA4
TA5	R7	R7	RA5
TA6	G2	G2	RA6
TB0	G3	G3	RB0
TB1	G4	G4	RB1
TB2	G5	G5	RB2
TB3	G6	G6	RB3
TB4	G7	G7	RB4
TB5	B2	B2	RB5
TB6	B3	B3	RB6
TC0	B4	B4	RC0
TC1	B5	B5	RC1
TC2	B6	B6	RC2
TC3	B7	B7	RC3
TC4	Hsync	Hsync	RC4
TC5	Vsync	Vsync	RC5
TC6	DE	DE	RC6
TD0	-	R0	RD0
TD1	-	R1	RD1
TD2	-	G0	RD2
TD3	-	G1	RD3
TD4	-	B0	RD4
TD5	-	B1	RD5
TD6	-	N/A	RD6

Note : Use TA to TC channels and open TD channel for 6bit application. **Table 8. Data Mapping for JEIDA Format** 

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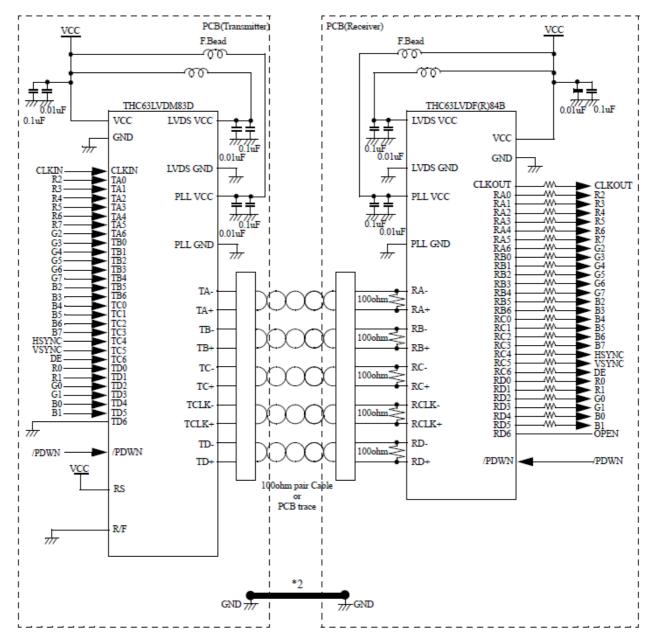
TX Pin	6bit	8bit	RX Pin
TA0	R0	R0	RA0
TA1	R1	R1	RA1
TA2	R2	R2	RA2
TA3	R3	R3	RA3
TA4	R4	R4	RA4
TA5	R5	R5	RA5
TA6	G0	G0	RA6
TB0	G1	G1	RB0
TB1	G2	G2	RB1
TB2	G3	G3	RB2
TB3	G4	G4	RB3
TB4	G5	G5	RB4
TB5	B0	B0	RB5
TB6	B1	B1	RB6
TC0	B2	B2	RC0
TC1	B3	B3	RC1
TC2	B4	B4	RC2
TC3	B5	B5	RC3
TC4	Hsync	Hsync	RC4
TC5	Vsync	Vsync	RC5
TC6	DE	DE	RC6
TD0	-	R6	RD0
TD1	-	R7	RD1
TD2	-	G6	RD2
TD3	-	G7	RD3
TD4	-	B6	RD4
TD5	-	B7	RD5
TD6	-	N/A	RD6

Pixel Data Mapping for VESA Format (6bit, 8bit Application)

Note : Use TA to TC channels and open TD channel for 6bit application. Table 9. Data Mapping for VESA Format

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## Normal Connection with JEIDA Format

Figure 10. Typical Connection Diagram



## Notes

 Cable Connection and Disconnection Do not connect and disconnect the LVDS cable, when the power is supplied to the system.

#### 2) GND Connection

Connect each GND of the PCB which THC63LVDM83D and LVDS-Rx on it. It is better for EMI reduction to place GND cable as close to LVDS cable as possible.

#### 3) Multi Drop Connection

Multi drop connection is not recommended.

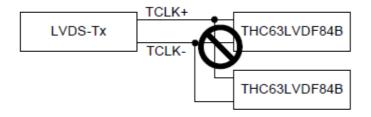
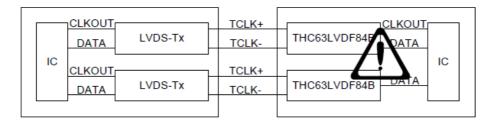


Figure 11. Multi Drop Connection

#### 4) Asynchronous use

Asynchronous using such as following systems is not recommended.



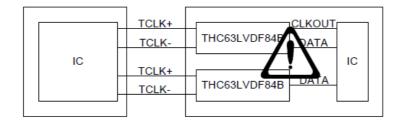
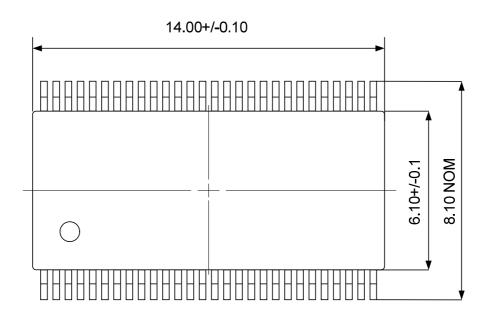


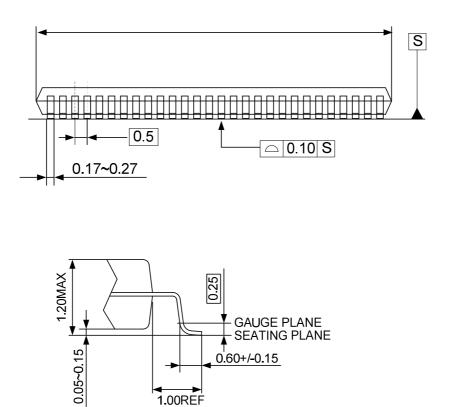
Figure 12. Asynchronous Use

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Package





UNIT:mm



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## Reference Land Pattern

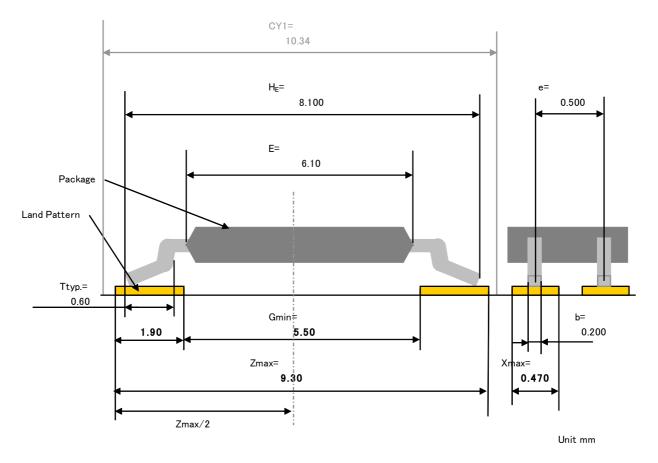


Figure 14. Reference of Land Pattern

The recommendation mounting method of THine device is reflow soldering. The reference pattern is using the calculation result on condition of reflow soldering.

Notes

This land pattern design is a calculated value based on JEITA ET-7501.

Please take into consideration in an actual substrate design about enough the ease of mounting, the intensity of connection, the density of mounting, and the solder paste used, etc... The optimal land pattern size changes with these parameters. Please use the value shown by the land pattern as reference data.

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